

November 2013

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FDMS3662 N-Channel Power Trench[®] MOSFET

FDMS3662 N-Channel Power Trench[®] MOSFET 100V, 39A, 14.8m Ω

Features

- Max $r_{DS(on)} = 14.8 m\Omega$ at $V_{GS} = 10V$, $I_D = 8.9A$
- Advanced Package and Silicon combination for low r_{DS(on)}
- MSL1 robust package design
- 100% UIL Tested
- RoHS Compliant

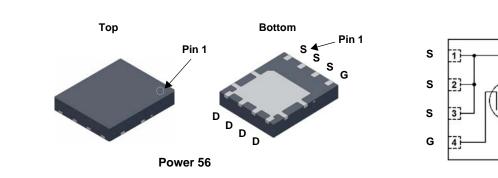


General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench[®] process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

Application

DC - DC Conversion



MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter			Ratings	Units
V _{DS}	Drain to Source Voltage			100	V
V _{GS}	Gate to Source Voltage			±20	V
	Drain Current -Continuous	$T_{C} = 25^{\circ}C$		39	
I _D	-Continuous	T _A = 25°C	(Note 1a)	8.9	Α
	-Pulsed			90	
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	384	mJ
P _D	Power Dissipation	T _C = 25°C		104	14/
	Power Dissipation	$T_A = 25^{\circ}C$	(Note 1a)	2.5	W
T _J , T _{STG}	Operating and Storage Junction Tempera	iture Range		-55 to +150	°C

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	1.2	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient (Note 1a)	50	C/vv

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS3662	FDMS3662	Power 56	13"	12mm	3000 units

FDMS3662
N-Channel F
ower
Trench®
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Off Chara ^{BV_{DSS} ∆BV_{DSS}}	cteristics					
	Drain to Source Breakdown Voltage	$I_{D} = 250 \mu A, V_{GS} = 0 V$	100			V
	Breakdown Voltage Temperature			74		
ΔT_{J}	Coefficient	$I_D = 250\mu A$, referenced to 25°C		74		mV/°C
DSS	Zero Gate Voltage Drain Current	$V_{GS} = 0V, V_{DS} = 80V,$			1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$			±100	nA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$	2.5	3.5	4.5	V
$\Delta V_{GS(th)}$	Gate to Source Threshold Voltage	$I_{\rm D} = 250 \mu \text{A}$, referenced to 25°C		-10.8		mV/°(
ΔT_{J}	Temperature Coefficient				44.0	
r _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 10V, I_D = 8.9A$		11.4	14.8	mΩ
	Forward Transconductors	$V_{GS} = 10V, I_D = 8.9A, T_J = 125^{\circ}C$		19.0	24.7	<u> </u>
9fs	Forward Transconductance	$V_{DD} = 10V, I_D = 8.9A$		37		S
Dynamic (Characteristics					
C _{iss}	Input Capacitance			3470	4620	pF
C _{oss}	Output Capacitance	V _{DS} = 50V, V _{GS} = 0V, f = 1MHz		245	325	pF
C _{rss}	Reverse Transfer Capacitance			110	165	pF
R _g	Gate Resistance	f = 1MHz		1.4		Ω
Switching	Characteristics					
t _{d(on)}	Turn-On Delay Time			25	40	ns
r	Rise Time	V _{DD} = 50V, I _D = 8.9A,		15	26	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10V, R_{GEN} = 6\Omega$		32	52	ns
t _f	Fall Time	GG / GEN		6	10	ns
Q _g	Total Gate Charge at 10V			54	75	nC
∽g Q _{gs}	Gate to Source Charge	$V_{DD} = 50V,$		18		nC
Q _{gd}	Gate to Drain "Miller" Charge	I _D = 8.9A		15		nC
	Irce Diode Characteristics					
		V _{GS} = 0V, I _S = 8.9A (Note 2)		0.8	1.3	V
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0V, I_S = 0.0A$ (Note 2) $V_{GS} = 0V, I_S = 2.1A$ (Note 2)		0.0	1.2	v
t _{rr}	Reverse Recovery Time			45	73	ns
Q _{rr}	Reverse Recovery Charge	— I _F = 8.9A, di/dt = 100A/μs		71	115	nC

Test Conditions

Min

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Max

Units

Electrical Characteristics T_J = 25°C unless otherwise noted

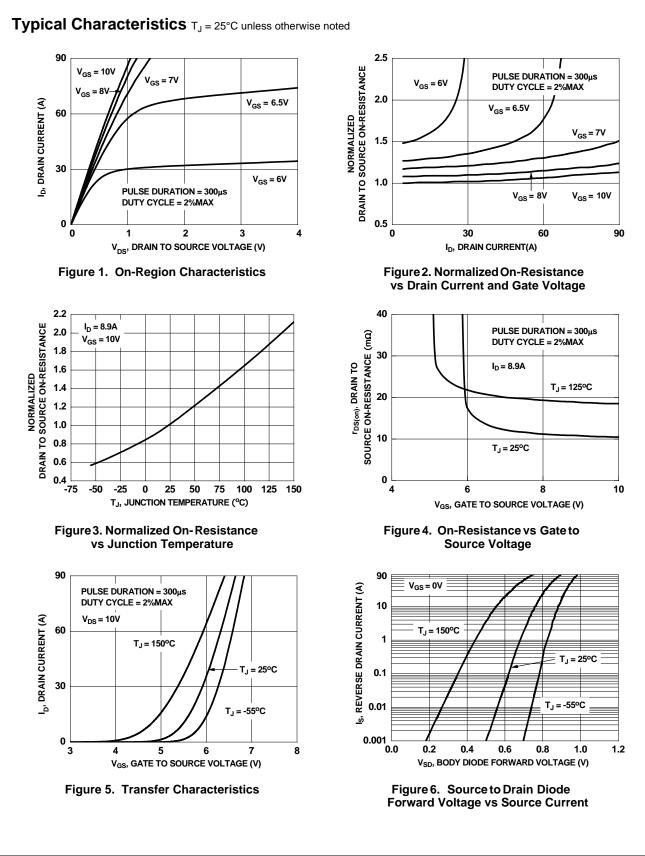
Parameter

Symbol

2. Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0%.

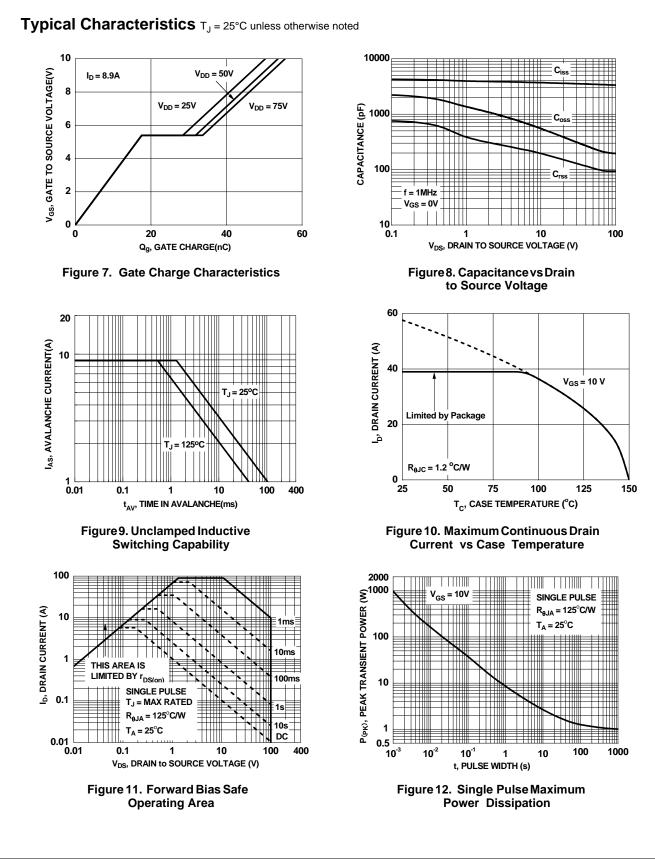
3. Starting T_J = 25°C, L = 3mH, I_{AS} = 16A, V_{DD} = 100V, V_{GS} = 10V

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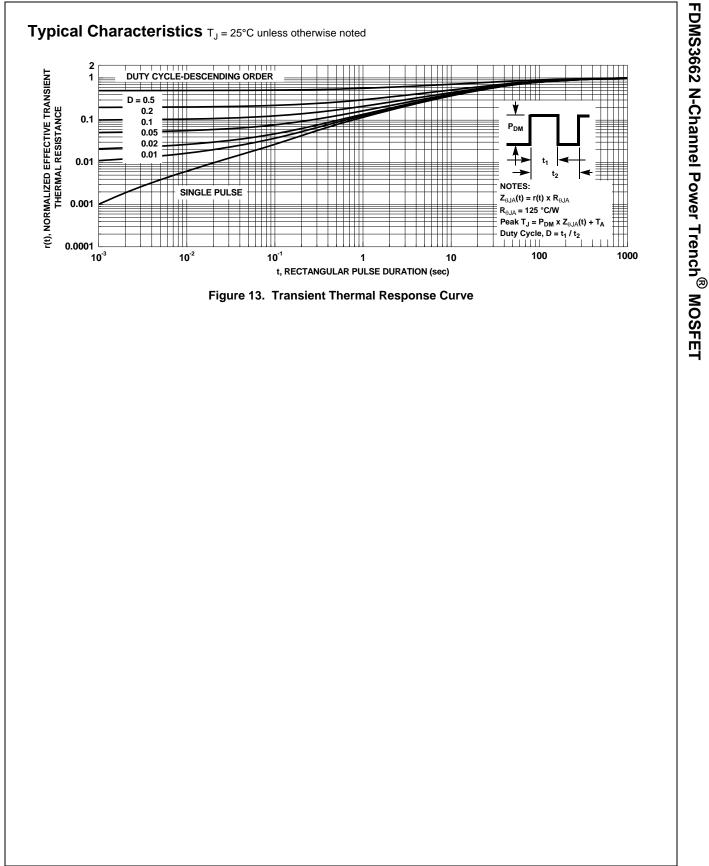
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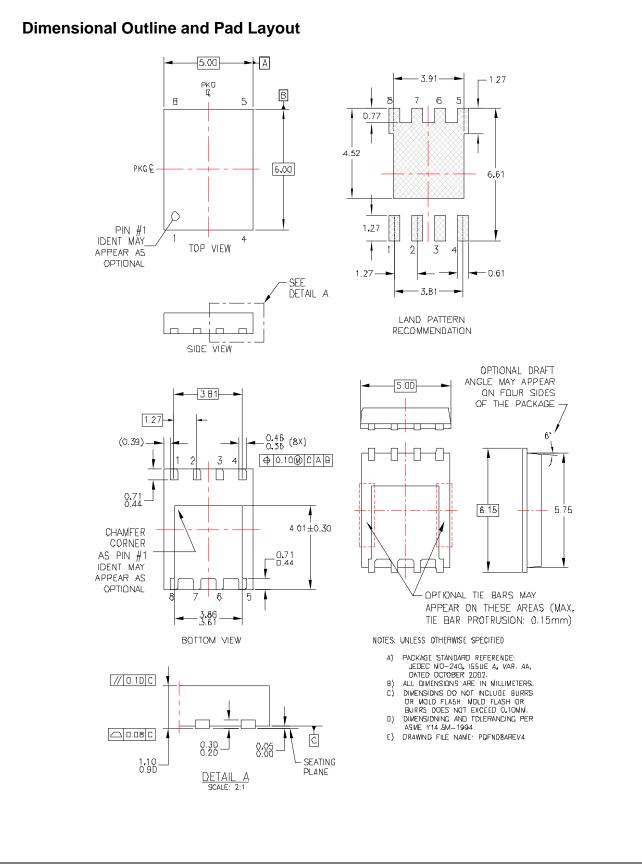




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